

June 1996 Revised November 2000

# 74ACT1284 IEEE 1284 Transceiver

#### **General Description**

The 74ACT1284 contains four non-inverting bidirectional buffers and three non-inverting buffers with open Drain outputs and high drive capability on the B Ports. It is intended to provide a standard signaling method for a bi-direction parallel peripheral in an Extended Capabilities Port mode (ECP).

The HD (active HIGH) input pin enables the B Ports to switch from open Drain to a high drive totem pole output, capable of sourcing 14 mA on all seven buffers. The DIR input determines the direction of data flow on the bidirectional buffers. DIR (active HIGH) enables data flow from A Ports to B Ports. DIR (active LOW) enables data flow from B Ports to A Ports.

#### **Features**

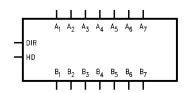
- TTL-compatible inputs
- A Ports have standard 4 mA totem pole outputs
- Typical input hysteresis of 0.5V
- B Port high drive source/sink capability of 14 mA
- Bidirectional non-inverting buffers
- Supports IEEE P1284 Level 1 and Level 2 signaling standards for bidirectional parallel communications between personal computers and printing peripherals
- B Port outputs in High Impedance mode during power
- Guaranteed 4000V minimum ESD protection

#### **Ordering Code:**

Order Number	Package Number	Package Description
74ACT1284SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74ACT1284MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74ACT1284MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

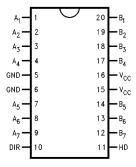
#### **Logic Symbol**



#### **Pin Descriptions**

Pin Names	Description					
HD	High Drive Enable input (Active HIGH)					
DIR	Direction Control Input					
A <sub>1</sub> - A <sub>4</sub>	Side A Inputs or Outputs					
A <sub>1</sub> - A <sub>4</sub> B <sub>1</sub> - B <sub>4</sub> A <sub>5</sub> - A <sub>7</sub>	Side B Inputs or Outputs					
A <sub>5</sub> - A <sub>7</sub>	Side A Inputs					
B <sub>5</sub> - B <sub>7</sub>	Side B Outputs					

#### **Connection Diagram**



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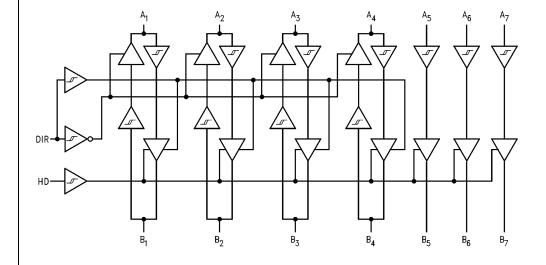
DS011683

# **Truth Table**

Inp	uts	Outputs		
DIR	HD			
L	L	B <sub>1</sub> - B <sub>4</sub> Data to A <sub>1</sub> - A <sub>4</sub> , and		
		A <sub>5</sub> - A <sub>7</sub> Data to B <sub>5</sub> - B <sub>7</sub> (Note 1)		
L	Н	B <sub>1</sub> - B <sub>4</sub> Data to A <sub>1</sub> - A <sub>4</sub> , and		
		A <sub>5</sub> - A <sub>7</sub> Data to B <sub>5</sub> - B <sub>7</sub>		
Н	L	A <sub>1</sub> - A <sub>7</sub> Data to B <sub>1</sub> - B <sub>7</sub> (Note 2)		
Н	Н	A <sub>1</sub> - A <sub>7</sub> Data to B <sub>1</sub> - B <sub>7</sub>		

Note 1: B<sub>5</sub> - B<sub>7</sub> Open Drain Outputs Note 2: B<sub>1</sub> - B<sub>7</sub> Open Drain Outputs

# **Logic Diagram**



#### **Absolute Maximum Ratings**(Note 3)

(Note 4)

-0.5V to +7.0V Supply Voltage (V<sub>CC</sub>)

DC Input Diode Current (I<sub>IK</sub>)

 $V_1 = -0.5V$ -20 mA  $V_I = V_{CC} + 0.5V$ +20 mA

DC Input Voltage (V<sub>I</sub>) A Side -0.5V to  $V_{CC} + 0.5V$ -2V to +7V

DC Input Voltage (V<sub>I</sub>) B Side

DC Output Diode Current (I<sub>OK</sub>)

-20 mA  $V_O = -0.5V$ +20 mA  $V_O = V_{CC} + 0.5V$ 

DC Output Voltage (V<sub>O</sub>) A Side -0.5V to  $V_{CC} + 0.5V$ DC Output Voltage ( $V_O$ ) B Side -2V to +7V

DC Output Source

or Sink Current (I<sub>O</sub>)  $\pm$  50 mA

DC V<sub>CC</sub> or Ground Current

per Output Pin ( $I_{CC}$  or  $I_{GND}$ )  $\pm\,50\;mA$ Storage Temperature (T<sub>STG</sub>)  $-65^{\circ}C$  to  $+150^{\circ}C$ 

#### **Recommended Operating Conditions**

Supply Voltage (V<sub>CC</sub>) 4.7V to 5.5V 0V to V<sub>CC</sub> Input Voltage (V<sub>I</sub>) Output Voltage (V<sub>O</sub>) 0V to  $V_{CC}$ -40°C to +85°C Operating Temperature (T<sub>A</sub>)

**Note 3:** Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of FACT™ circuits outside databook specifications.

Note 4: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

Parameter	v <sub>cc</sub>	Guaranteed Limits				Conditions	
	(V)	$T_A = +25^{\circ}C$	$T_A = 0^{\circ}C \text{ to } +70^{\circ}C$	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	Units	Conditions	
Minimum HIGH Level	4.7	2.0	2.0	2.0	\/	Recognized	
Input Voltage	5.5	2.0	2.0	2.0	V	High Signal	
Maximum LOW Level	4.7	0.8	0.8	0.8	\/	Recognized	
Input Voltage	5.5	0.8	0.8	0.8	V	Low Signal	
Minimum HIGH Level		4.5	4.5	4.5		$I_{OUT} = -50 \mu A (An)$	
Output Voltage	4.7				.,	$V_{IN} = V_{IL}$ or $V_{IH}$ (Note 5)	
	4.7	3.7	3.7	3.7	V	$I_{OH} = -4 \text{ mA } (A_n)$	
		2.4	2.4	2.4		$I_{OH} = -14 \text{ mA } (B_n)$	
Maximum LOW Level		0.2	0.2	0.2		I <sub>OUT</sub> = 50 μA (An)	
Output Voltage	4.7				.,	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> (Note 5)	
		0.4	0.4	0.4	V	$I_{OH} = 4 \text{ mA } (A_n)$	
						$I_{OH} = 14 \text{ mA } (B_n)$	
Maximum Input			±0.1	+1.0		$V_I = V_{CC}$ , GND	
Leakage Current	5.5		±0.1	±1.0	μА	(DIR, A5, A6, A7, HD)	
Maximum I <sub>CC</sub> /Input	5.5		1.5	1.5	mA	$V_{I} = V_{CC} - 2.1V$	
Maximum Quiescent	E E	5 400 400 500	F00		$V_{IN} = V_{CC}$ or GND		
Supply Current	5.5	400	400	500	μА	AIN - ACC OL GIAD	
Maximum Output		±20	±20	±20	μА	V V CND	
Leakage Current	5.5					$V_O = V_{CC}$ , GND	
Maximum B-Side Power Down	0.0	100	100	100	μА	V 5.25V	
Leakage Current	0.0					V <sub>OUT</sub> = 5.25V	
Input Hysteresis	5.0	0.4	0.4	0.35	V	$V_T + - V_{T^-}$	
Maximum Output Impedance	5.0	22	22	24	Ω	B <sub>n</sub> (Note 6)	
Minimum Output Impedance	5.0	8	8	6	Ω	B <sub>n</sub> (Note 6)	
	Minimum HIGH Level Input Voltage Maximum LOW Level Input Voltage Minimum HIGH Level Output Voltage  Maximum LOW Level Output Voltage  Maximum Input Leakage Current Maximum Quiescent Supply Current Maximum Output Leakage Current Maximum B-Side Power Down Leakage Current Input Hysteresis Maximum Output Impedance	Minimum HIGH Level 4.7 Input Voltage 5.5 Maximum LOW Level 4.7 Input Voltage 5.5 Minimum HIGH Level 5.5 Minimum HIGH Level 0utput Voltage 4.7  Maximum LOW Level 4.7  Maximum LOW Level 5.5 Maximum Input 1.00 Leakage Current 5.5 Maximum Quiescent 5.5 Maximum Quiescent 5.5 Maximum Output 1.00 Maximum B-Side Power Down 1.00 Leakage Current 1.00 Input Hysteresis 5.0 Maximum Output Impedance 5.0	Name	Name	Name	Parameter   (v)   T <sub>A</sub> = +25°C   T <sub>A</sub> = 0°C to +70°C   T <sub>A</sub> = -40°C to +85°C   Units	

Note 5: All outputs loaded; thresholds on input associated with output under test.

Note 6: This parameter is guaranteed but not tested, characterized only: RD is the measure of the B-Side output impedance with the output in the HIGH

# **AC Electrical Characteristics**

	Parameter	$T_{A} = +25^{\circ}C$ $V_{CC} = 4.7V - 5.5V$		$T_A = 0$ °C to +70°C $V_{CC} = 4.7V - 5.5V$		$T_A = -40$ °C to $+85$ °C $V_{CC} = 4.7V - 5.5V$		Units	Figure Number
Symbol									
		Min	Max	Min	Max	Min	Max		
t <sub>PHL</sub>	A <sub>1</sub> - A <sub>7</sub> to B <sub>1</sub> - B <sub>7</sub>	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 1
t <sub>PLH</sub>	A <sub>1</sub> - A <sub>7</sub> to B <sub>1</sub> - B <sub>7</sub>	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 2
t <sub>PHL</sub>	B <sub>1</sub> - B <sub>4</sub> to A <sub>1</sub> - A <sub>4</sub>	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 3
t <sub>PLH</sub>	B <sub>1</sub> - B <sub>4</sub> to A <sub>1</sub> - A <sub>4</sub>	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 3
t <sub>pEnable</sub>	Output Enable Time	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 2
	HD to B <sub>1</sub> - B <sub>7</sub>	2.0	20.0	2.0	20.0	2.0	24.0	115	i iguie 2
t <sub>pDisable</sub>	Output Disable Time	2.0	20.0	2.0	2.0 20.0	2.0	24.0	ns	Figure 2
	HD to B <sub>1</sub> - B <sub>7</sub>								
t <sub>SKEW</sub>	Output Slew Rate								
t <sub>PLH</sub>	B <sub>1</sub> - B <sub>7</sub>	0.05	0.40	0.05	0.40	0.05	0.40	V/ns	Figures 1, 2
t <sub>PHL</sub>									., _
t <sub>r</sub> , t <sub>f</sub>	t <sub>RISE</sub> and t <sub>FALL</sub>		120	120	120		120	ns	Figure 4
	B <sub>1</sub> - B <sub>7</sub> (Note 7)		120		120				(Note 8)

Note 7: Open Drain

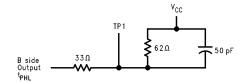
Note 8: This parameter is guaranteed but not tested, characterized only.

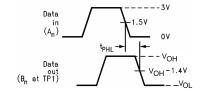
**Note:** Pulse Generator for all pulses; Rate  $\leq$  1.0 MHz; A  $_{O}$   $\leq$  500;  $t_{f}$   $\leq$  2.5 ns,  $t_{r}$   $\leq$  2.5 ns.

# Capacitance

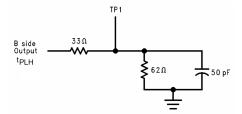
Symbol	Parameter	rameter Typ U		Conditions
C <sub>IN</sub>	Input Capacitance	4.0	pF	$V_{CC} = OPEN (HD, DIR A_5 - A_7)$
C <sub>I/O</sub>	I/O Pin Capacitance	12.0	pF	$V_{CC} = 5.0V$

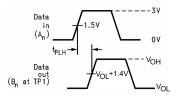
# **AC Loading and Waveforms**





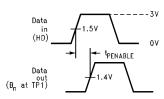
 $t_{\mbox{\scriptsize SLEW}}$  measures between 10% to 90% on the  $t_{\mbox{\scriptsize PHL}}$  Transition





 $t_{\mbox{\scriptsize SLEW}}$  measures between 10% to 90% on the  $t_{\mbox{\scriptsize PLH}}$  Transition

FIGURE 1. Port A to B Propagation Delay Waveforms



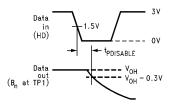
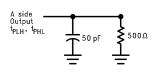


FIGURE 2. B Output Test Load and Waveforms



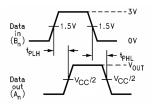
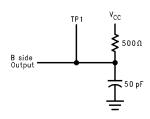


FIGURE 3. B to A Direction Test Load and Waveforms for Outputs A<sub>1</sub> - A<sub>4</sub>



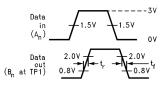
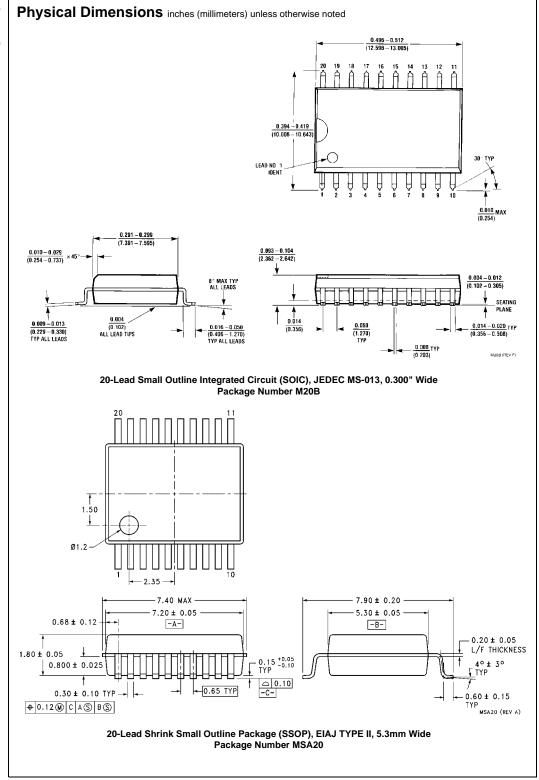
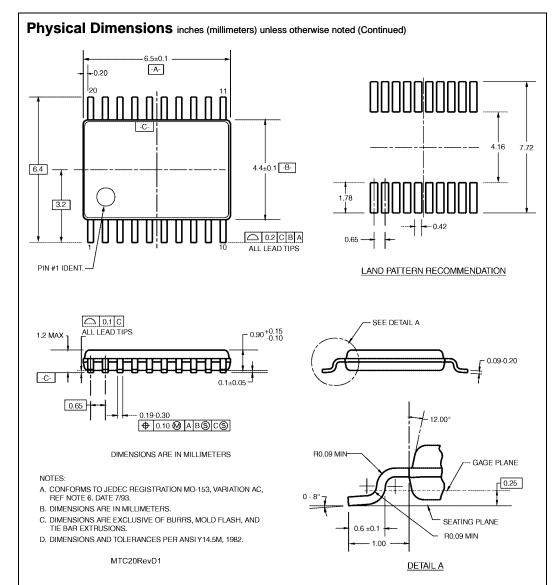


FIGURE 4. A to B Direction Test Load and Waveforms for Open Drain  $B_1$  -  $B_7$ 





# 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

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